

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

## 2SC2753

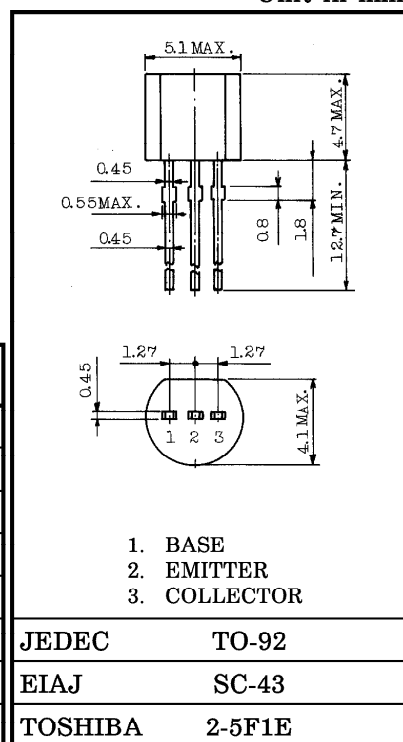
VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATION.

Unit in mm

- Low Noise Figure, High Gain
- $NF = 1.5\text{dB}$ ,  $|S_{21e}|^2 = 16\text{dB}$  ( $f = 500\text{MHz}$ )
- $NF = 1.7\text{dB}$ ,  $|S_{21e}|^2 = 10.5\text{dB}$  ( $f = 1\text{GHz}$ )

MAXIMUM RATINGS ( $T_a = 25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$V_{CB0}$	17	V
Collector-Emitter Voltage	$V_{CE0}$	12	V
Emitter-Base Voltage	$V_{EB0}$	3	V
Collector Current	$I_C$	70	mA
Base Current	$I_B$	30	mA
Collector Power Dissipation	$P_C$	300	mW
Junction Temperature	$T_j$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	$-55 \sim 125$	$^\circ\text{C}$



Weight : 0.21g

MICROWAVE CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transition Frequency	$f_T$	$V_{CE} = 10\text{V}$ , $I_C = 20\text{mA}$	—	5	—	GHz
Insertion Gain	$ S_{21e} ^2(1)$	$V_{CE} = 10\text{V}$ , $I_C = 20\text{mA}$ , $f = 500\text{MHz}$	—	16	—	dB
	$ S_{21e} ^2(2)$	$V_{CE} = 10\text{V}$ , $I_C = 20\text{mA}$ , $f = 1\text{GHz}$	—	10.5	—	dB
Noise Figure	NF(1)	$V_{CE} = 10\text{V}$ , $I_C = 5\text{mA}$ , $f = 500\text{MHz}$	—	1.5	—	dB
	NF(2)	$V_{CE} = 10\text{V}$ , $I_C = 5\text{mA}$ , $f = 1\text{GHz}$	—	1.7	—	dB

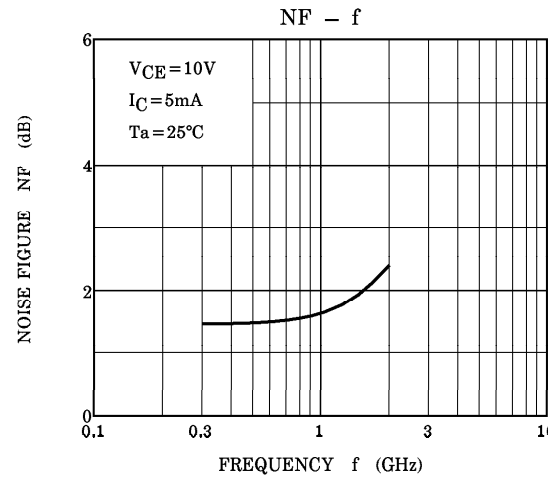
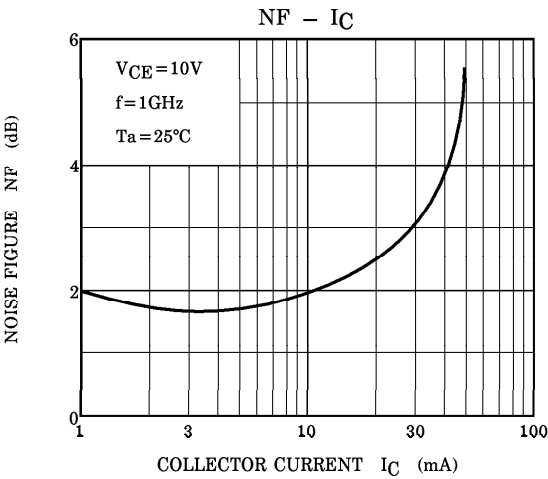
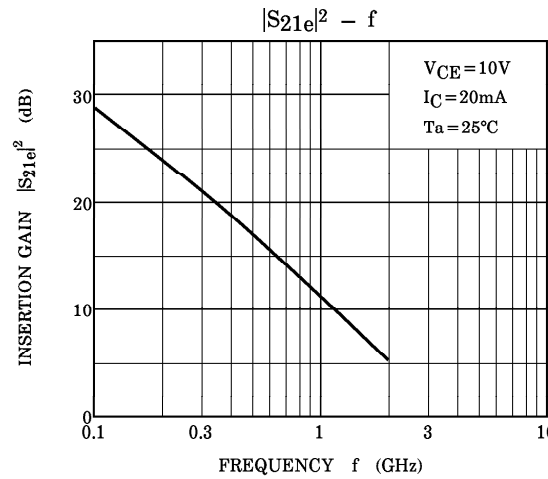
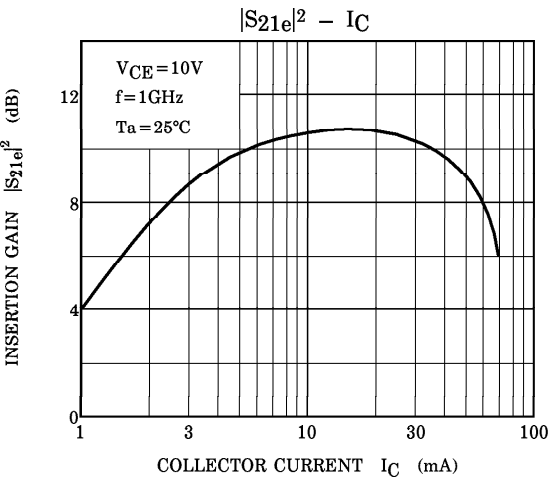
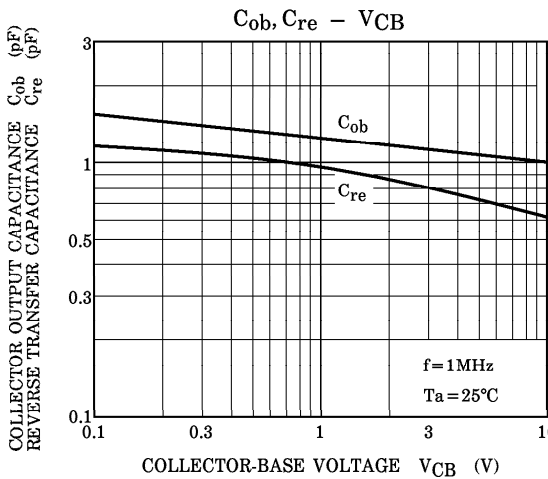
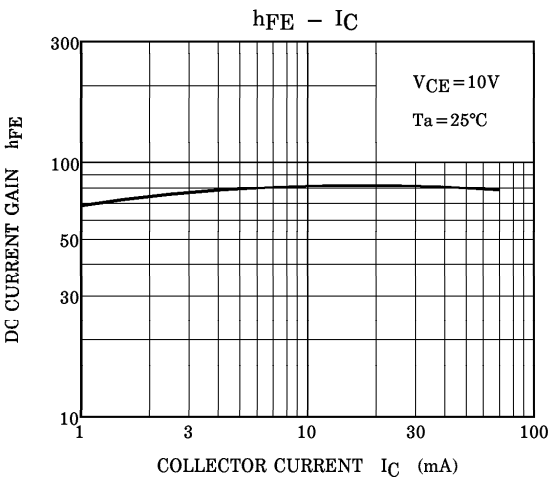
ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{CBO}$	$V_{CB} = 10\text{V}$ , $I_E = 0$	—	—	1	$\mu\text{A}$
Emitter Cut-off Current	$I_{EBO}$	$V_{EB} = 1\text{V}$ , $I_E = 0$	—	—	1	$\mu\text{A}$
DC Current Gain	$h_{FE}$	$V_{CE} = 10\text{V}$ , $I_C = 20\text{mA}$	30	—	180	—
Collector Output Capacitance	$C_{ob}$	$V_{CB} = 10\text{V}$ , $I_E = 0$ , $f = 1\text{MHz}$	—	1.1	—	pF
Reverse Transfer Capacitance	$C_{re}$	(Note)	—	0.65	—	pF

Note :  $C_{re}$  is measured by 3 terminal method with Capacitance Bridge.

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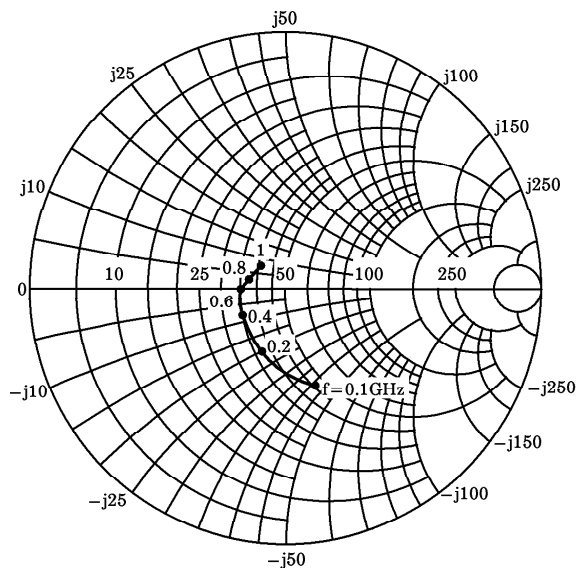


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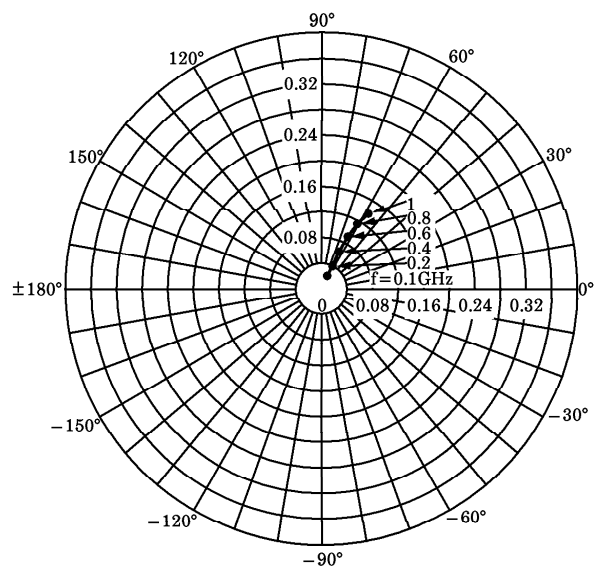
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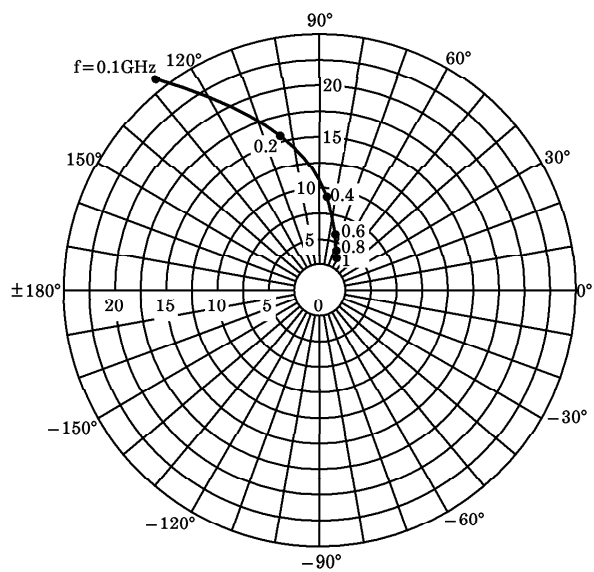
$S_{11e}$   
 $V_{CE} = 10V$   
 $I_C = 20mA$   
 $T_a = 25^\circ C$   
 (UNIT :  $\Omega$ )



$S_{12e}$   
 $V_{CE} = 10V$   
 $I_C = 20mA$   
 $T_a = 25^\circ C$



$S_{21e}$   
 $V_{CE} = 10V$   
 $I_C = 20mA$   
 $T_a = 25^\circ C$



$S_{22e}$   
 $V_{CE} = 10V$   
 $I_C = 20mA$   
 $T_a = 25^\circ C$   
 (UNIT :  $\Omega$ )

